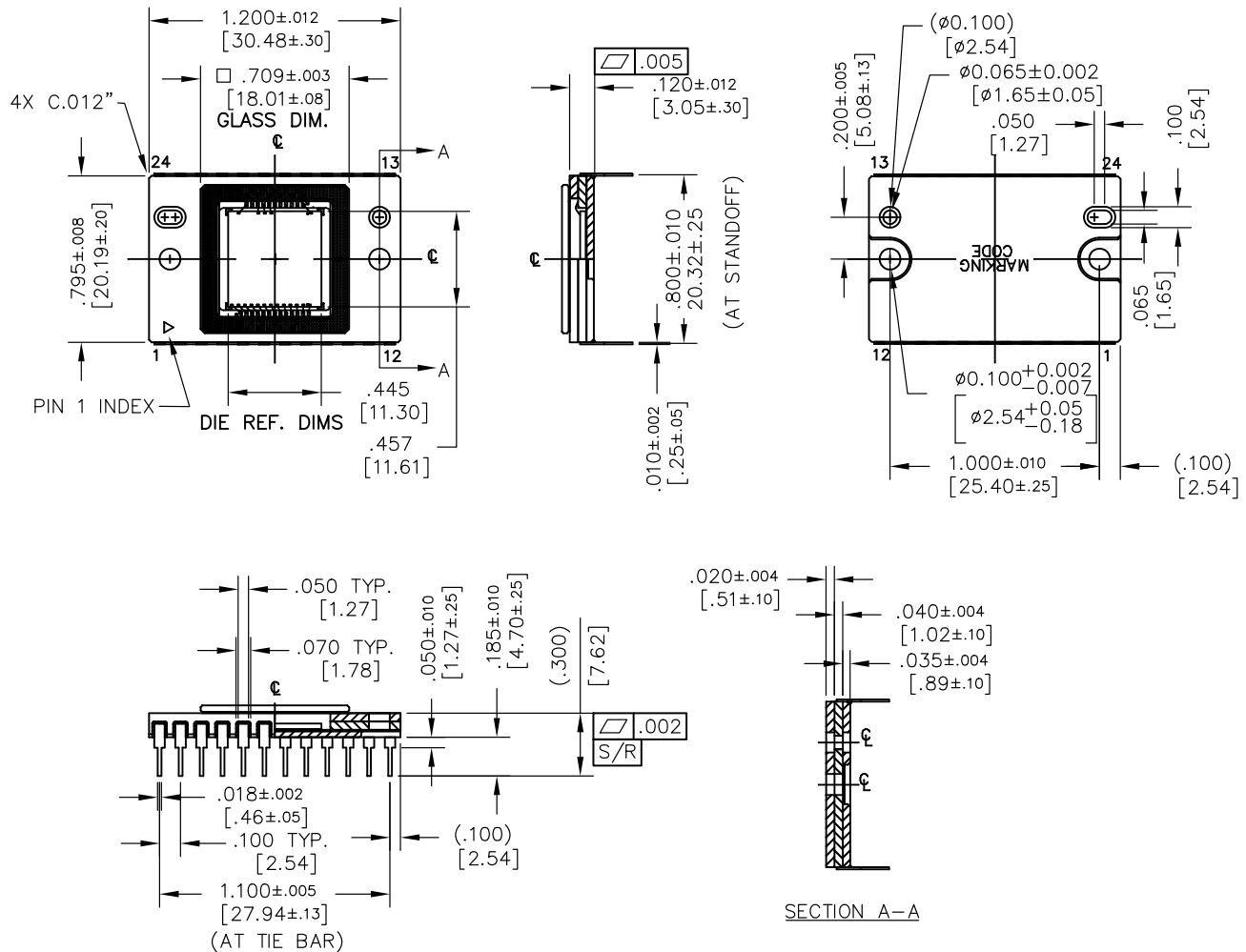


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NOTES:

1. COVER GLASS IS MANUALLY
PLACED AND VISUALLY ALIGNED
OVER DIE – LOCATION
ACCURACY IS NOT GUARANTEED.

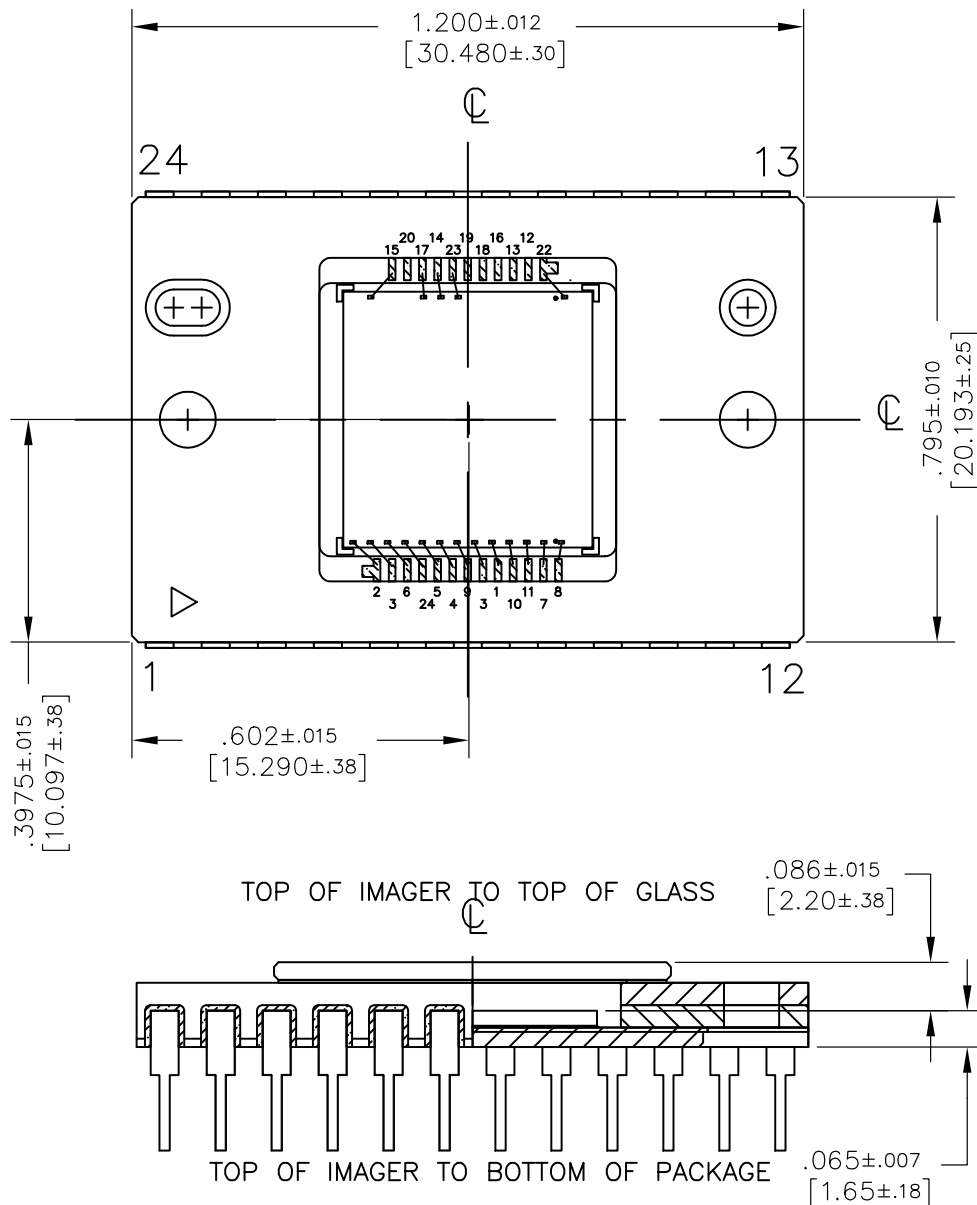
Dimensions in: Inches [mm]

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NOTES:

1. CENTER OF IMAGE IS OFFSET FROM CENTER OF PACKAGE BY (.05, .00)mm NOMINAL.
2. DIE IS ALIGNED WITHIN ± 2 DEGREE OF ANY PACKAGE CAVITY EDGE.

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